

### IGBT MODULE (S series) 1200V / 35A / PIM



#### ■ Features

- Low  $V_{CE(sat)}$
- Compact package
- P.C. board mount
- Converter diode bridge, Dynamic brake circuit

#### ■ Applications

- Inverter for motor drive
- AC and DC servo drive amplifier
- Uninterruptible power supply

#### ■ Maximum ratings and characteristics

● Absolute maximum ratings ( $T_c=25^\circ\text{C}$  unless without specified)

Item	Symbol	Condition	Rating	Unit		
Inverter	Collector-Emitter voltage	$V_{CES}$	1200	V		
	Gate-Emitter voltage	$V_{GES}$	$\pm 20$	V		
	Collector current	$I_C$	Continuous	$T_c=25^\circ\text{C}$	50	A
				$T_c=80^\circ\text{C}$	35	
		$I_{CP}$	1ms	$T_c=25^\circ\text{C}$	100	A
				$T_c=80^\circ\text{C}$	70	
$-I_C$			35	A		
Collector power dissipation	$P_C$	1 device	240	W		
Brake	Collector-Emitter voltage	$V_{CES}$	1200	V		
	Gate-Emitter voltage	$V_{GES}$	$\pm 20$	V		
	Collector current	$I_C$	Continuous	$T_c=25^\circ\text{C}$	35	A
				$T_c=80^\circ\text{C}$	25	
		$I_{CP}$	1ms	$T_c=25^\circ\text{C}$	70	A
				$T_c=80^\circ\text{C}$	50	
Collector power dissipation	$P_C$	1 device	180	W		
Repetitive peak reverse voltage	$V_{RRM}$		1200	V		
Converter	Repetitive peak reverse voltage	$V_{RRM}$	1600	V		
	Average output current	$I_O$	50Hz/60Hz sine wave	35	A	
	Surge current (Non-Repetitive)	$I_{FSM}$	$T_j=150^\circ\text{C}$ , 10ms	360	A	
	$I^2t$ (Non-Repetitive)	$I^2t$	half sine wave	648	$\text{A}^2\text{s}$	
Operating junction temperature	$T_j$		+150	$^\circ\text{C}$		
Storage temperature	$T_{stg}$		-40 to +125	$^\circ\text{C}$		
Isolation voltage	between terminal and copper base *2	$V_{iso}$	AC : 1 minute	AC 2500	V	
	between thermistor and others *3			AC 2500		
Mounting screw torque			3.5 *1	N·m		

\*1 Recommendable value : 2.5 to 3.5 N·m (M5)

\*2 All terminals should be connected together when isolation test will be done.

\*3 Terminal 8 and 9 should be connected together. Terminal 1 to 7 and 10 to 24 should be connected together and shorted to copper base.

## ● Electrical characteristics (T<sub>j</sub>=25°C unless otherwise specified)

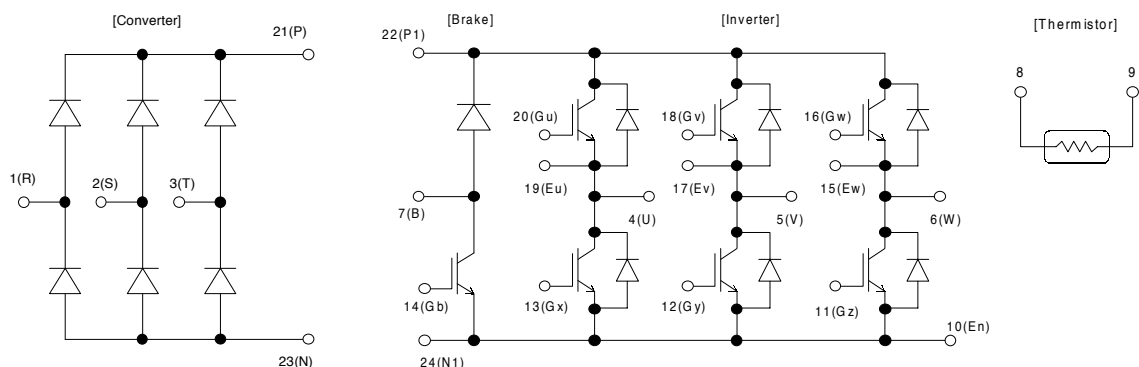
Item	Symbol	Condition	Characteristics			Unit		
			Min.	Typ.	Max.			
Inverter	Zero gate voltage collector current	ICES	V <sub>CE</sub> =1200V, V <sub>GE</sub> =0V		1.0	mA		
	Gate-Emitter leakage current	IGES	V <sub>CE</sub> =0V, V <sub>GE</sub> =±20V		0.2	μA		
	Gate-Emitter threshold voltage	V <sub>GE(th)</sub>	V <sub>CE</sub> =20V, I <sub>c</sub> =35mA		5.5	7.2	8.5	V
	Collector-Emitter saturation voltage	V <sub>CE(sat)</sub>	V <sub>GE</sub> =15V, I <sub>c</sub> =35A	chip	2.1		V	
				terminal	2.25	2.7		
	Input capacitance	C <sub>ies</sub>	V <sub>GE</sub> =0V, V <sub>CE</sub> =10V, f=1MHz		4200		pF	
	Turn-on time	t <sub>on</sub>	V <sub>CC</sub> =600V I <sub>c</sub> =35A V <sub>GE</sub> =±15V		0.35	1.2	μs	
					0.25	0.6		
					0.1			
	Turn-off	t <sub>off</sub>	R <sub>G</sub> =33Ω		0.45	1.0		
				0.08	0.3			
Forward on voltage	V <sub>F</sub>	I <sub>F</sub> =35A	chip	2.3		V		
			terminal	2.45	3.3			
Reverse recovery time of FRD	t <sub>rr</sub>	I <sub>F</sub> =35A			0.35	μs		
Brake	Zero gate voltage collector current	ICES	V <sub>CEs</sub> =1200V, V <sub>GE</sub> =0V		1.0	mA		
	Gate-Emitter leakage current	IGES	V <sub>CE</sub> =0V, V <sub>GE</sub> =±20V		0.2	μA		
	Collector-Emitter saturation voltage	V <sub>CE(sat)</sub>	I <sub>c</sub> =25A, V <sub>GE</sub> =15V	chip	2.1		V	
				terminal	2.25	2.7		
	Turn-on time	t <sub>on</sub>	V <sub>CC</sub> =600V I <sub>c</sub> =25A V <sub>GE</sub> =±15V		0.35	1.2	μs	
					0.25	0.6		
	Turn-off time	t <sub>off</sub>	R <sub>G</sub> =51Ω		0.45	1.0		
					0.08	0.3		
	Reverse current	I <sub>RRM</sub>	V <sub>R</sub> =1200V			1.0	mA	
	Forward on voltage	V <sub>FM</sub>	I <sub>F</sub> =35A	chip	1.1		V	
terminal				1.2	1.5			
Reverse current	I <sub>RRM</sub>	V <sub>R</sub> =1600V			1.0	mA		
Thermistor	Resistance	R	T=25°C		5000	Ω		
			T=100°C		465	495	520	
			T=25/50°C		3305	3375	3450	

## ● Thermal resistance Characteristics

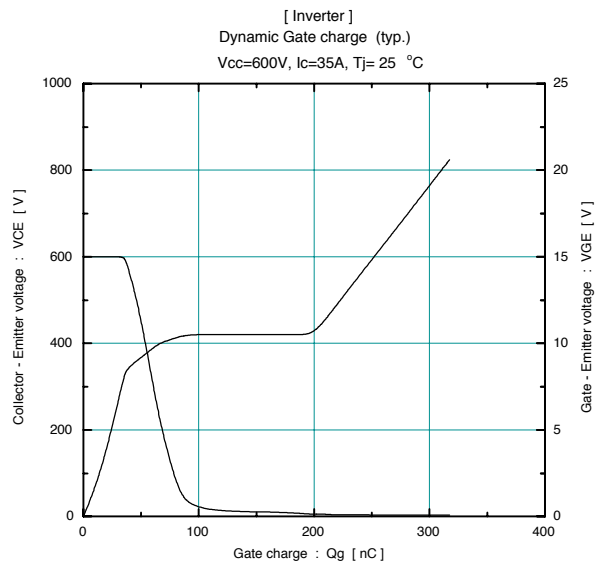
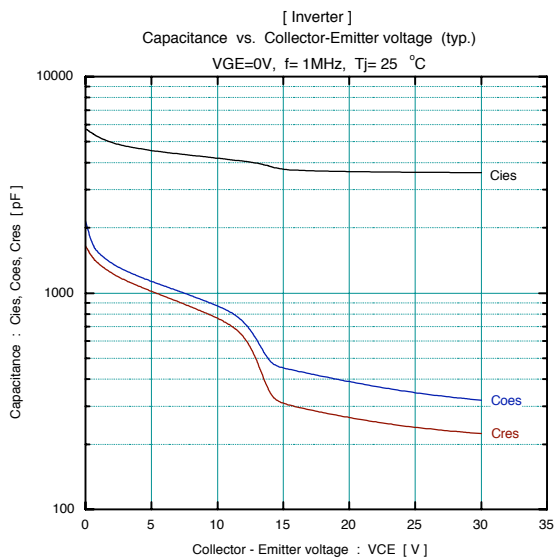
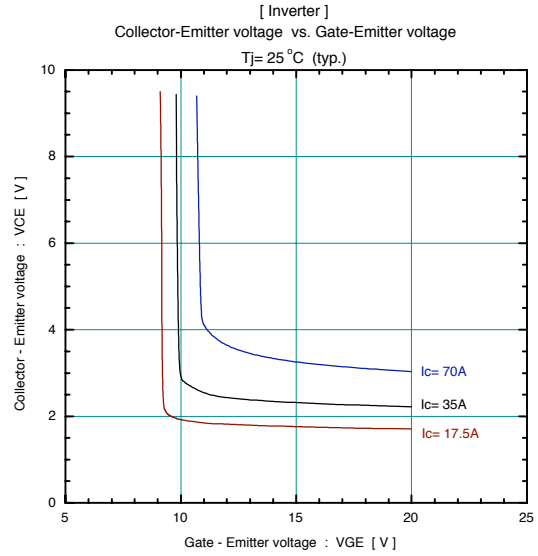
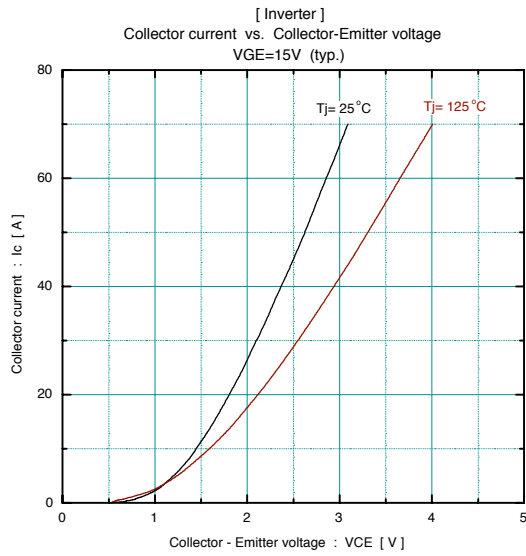
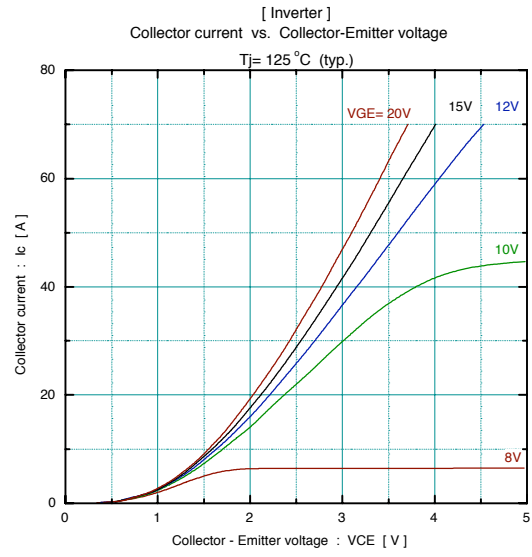
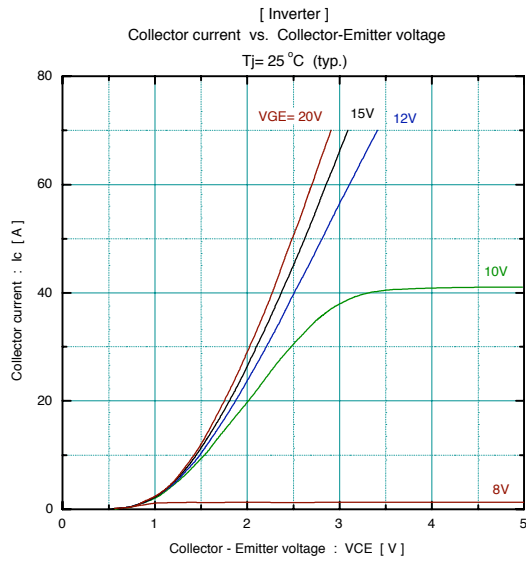
Item	Symbol	Condition	Characteristics			Unit
			Min.	Typ.	Max.	
Thermal resistance ( 1 device )	R <sub>th(j-c)</sub>	Inverter IGBT			0.52	°C/W
		Inverter FWD			0.90	
		Brake IGBT			0.69	
		Converter Diode			0.75	
Contact thermal resistance *	R <sub>th(c-f)</sub>	With thermal compound		0.05		

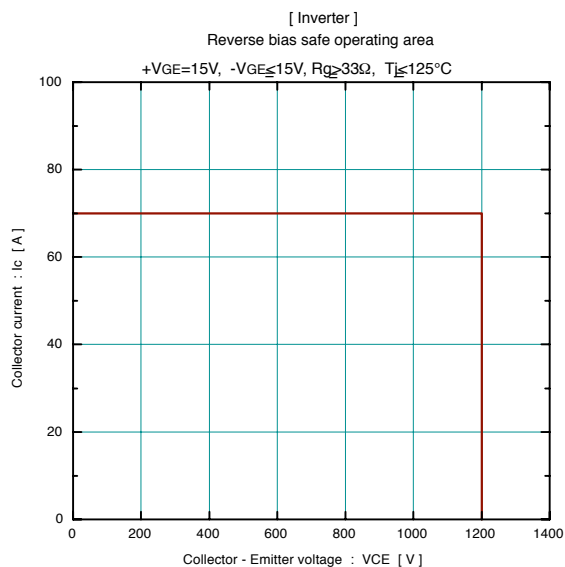
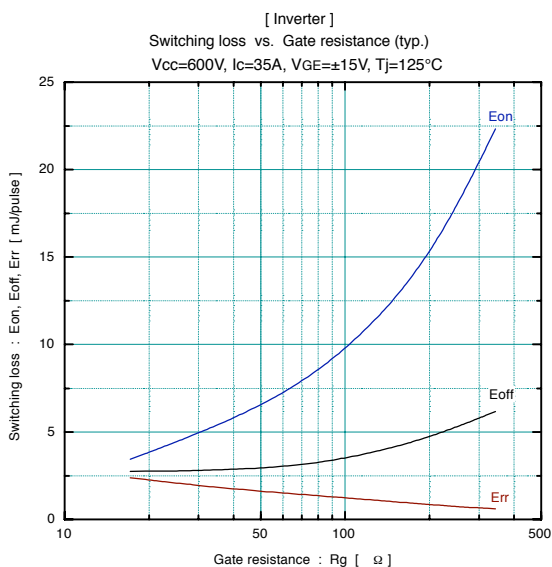
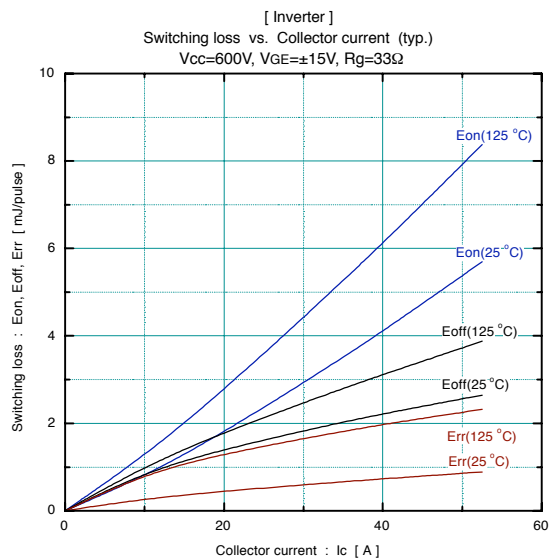
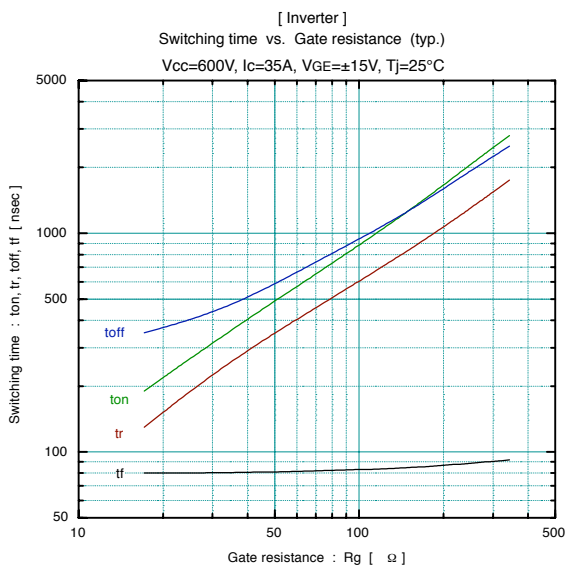
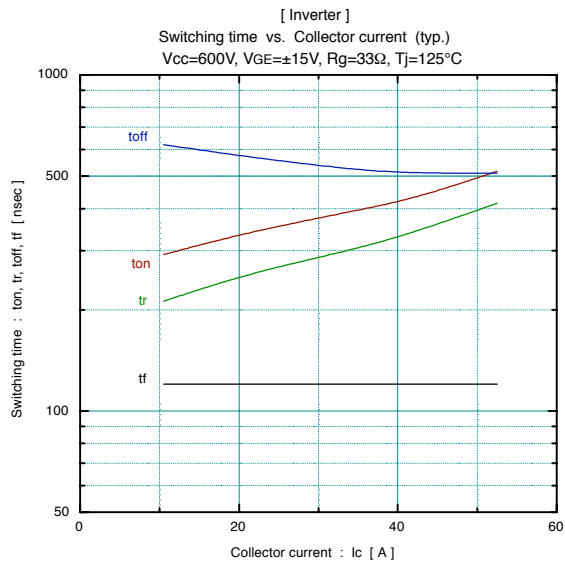
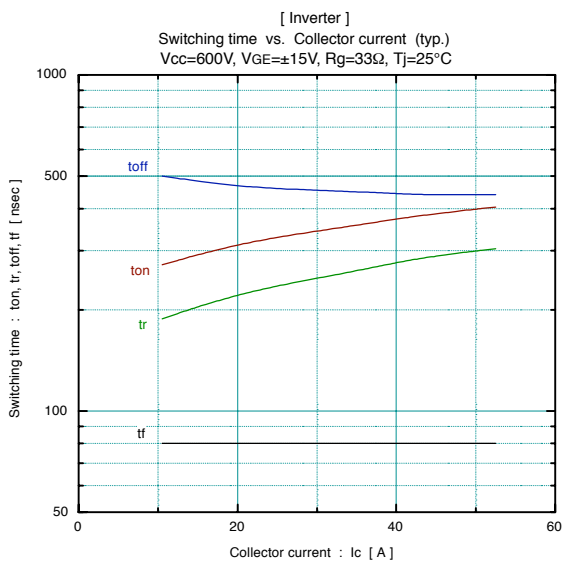
\* This is the value which is defined mounting on the additional cooling fin with thermal compound

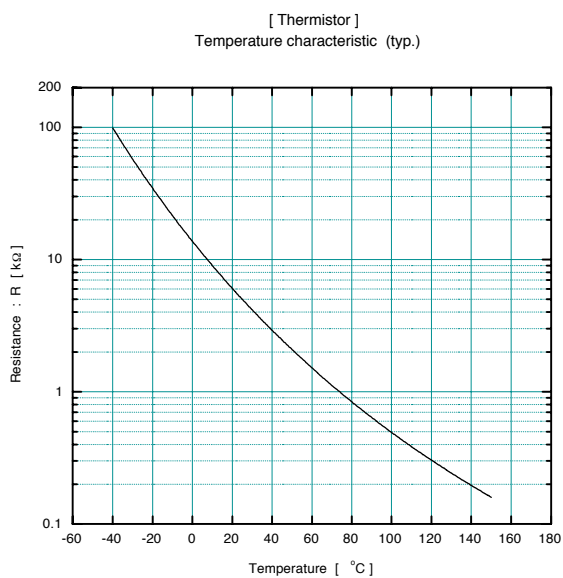
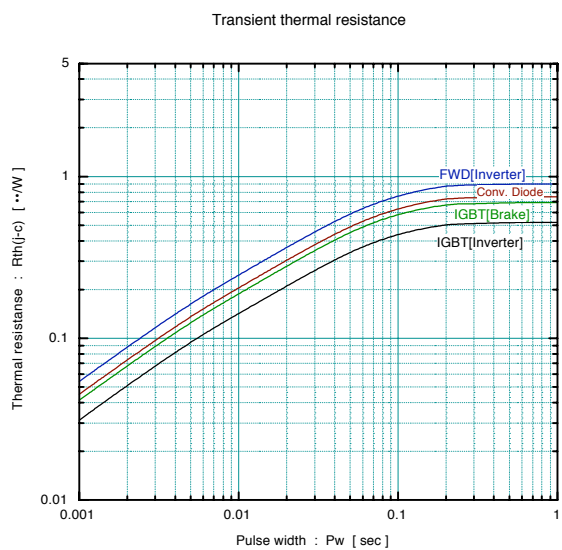
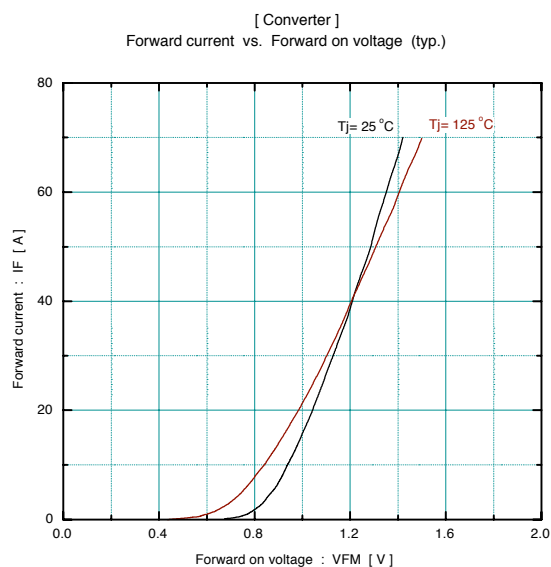
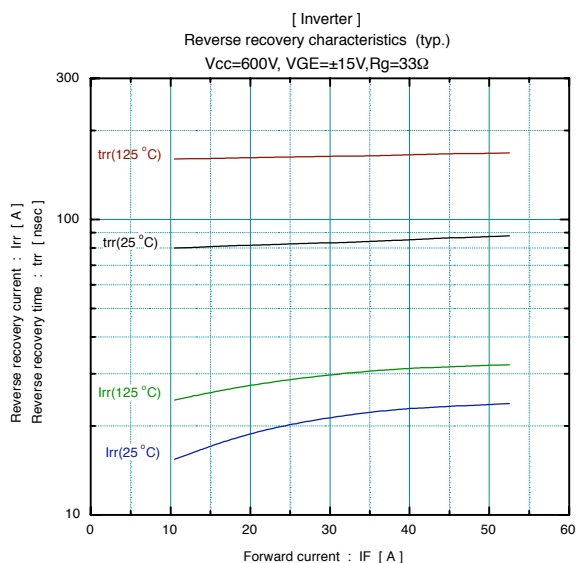
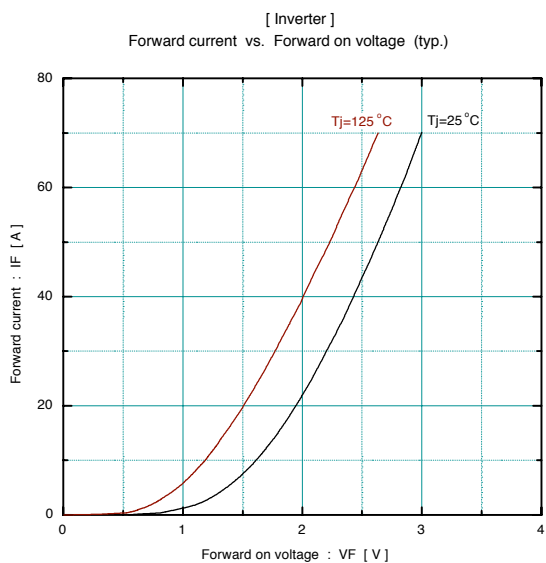
## ■ Equivalent Circuit Schematic

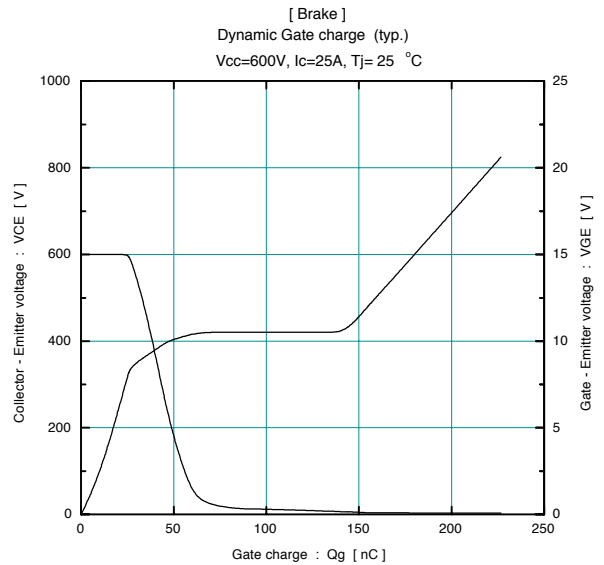
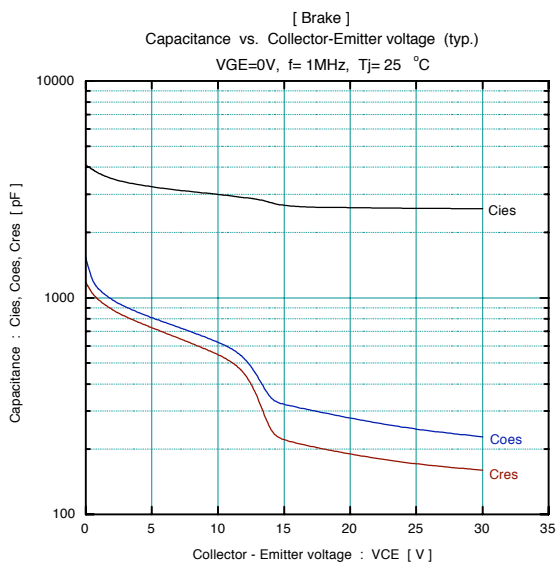
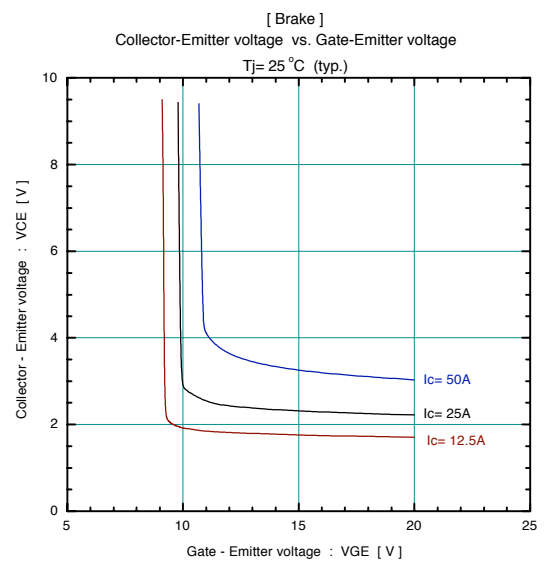
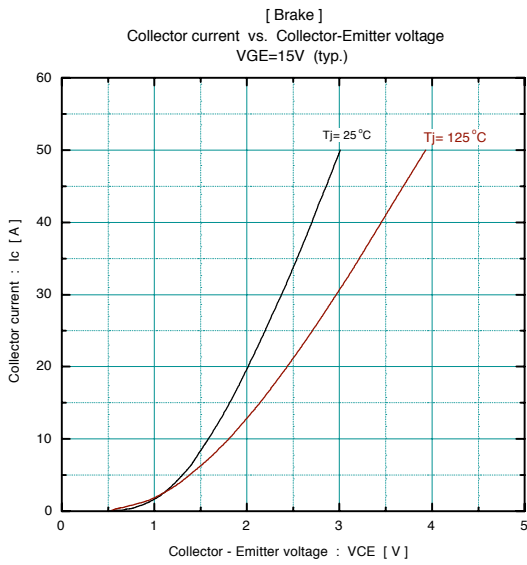
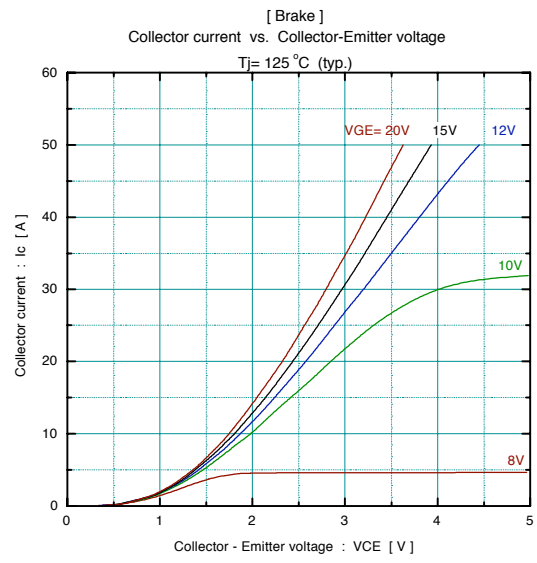
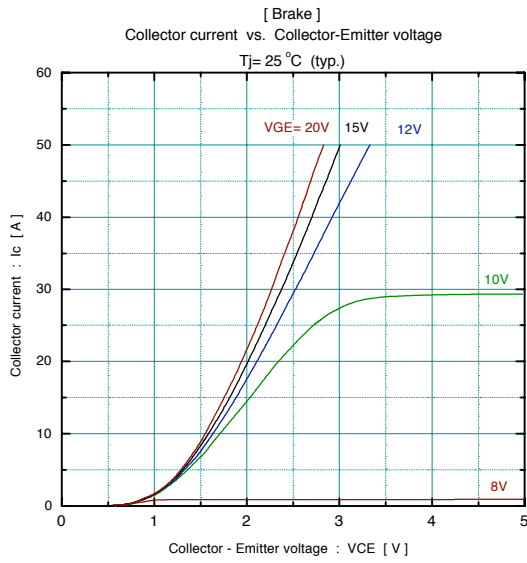


## ■ Characteristics (Representative)

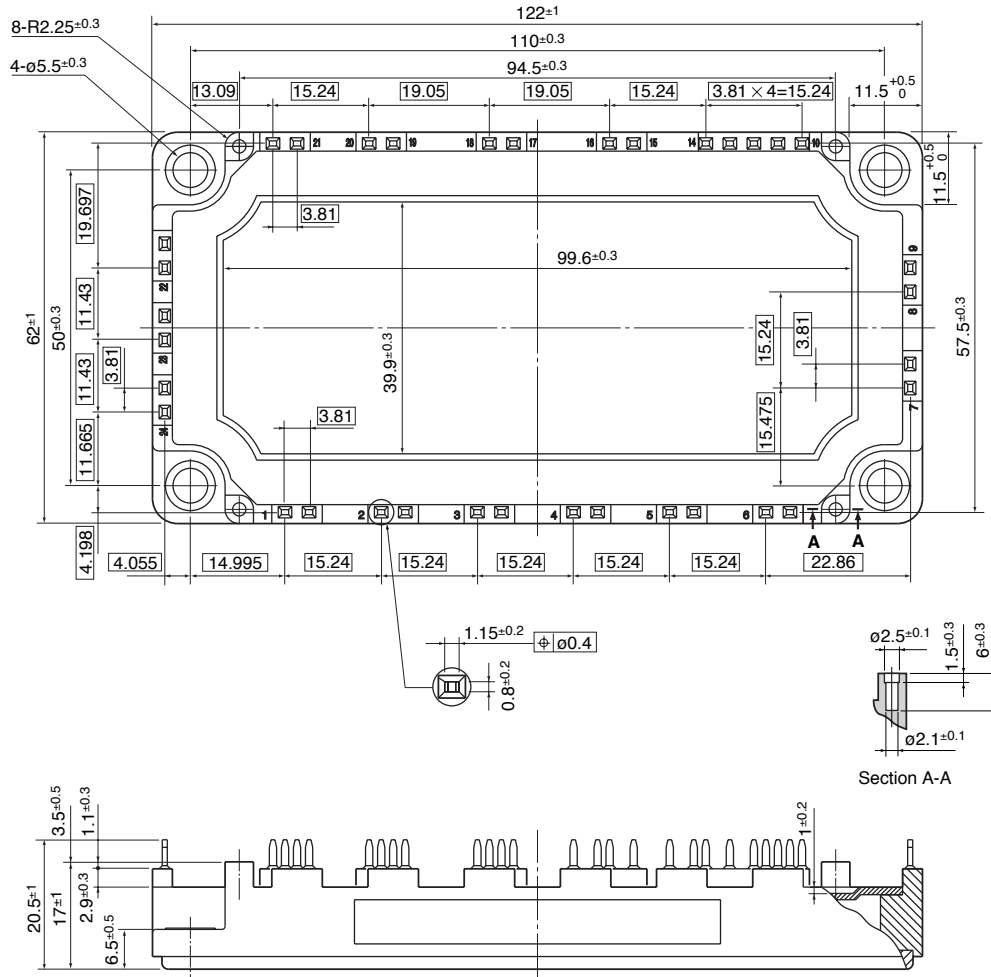








■ Outline Drawings, mm



□ Shows theory dimensions